LMC2001 High Precision, 6MHz Rail-To-Rail Output Operational Amplifier



Literature Number: SNOS011C



.

MC2001 High Precision, 6MHz Rail-To-Rail Output Operational Amplifier

High Precision, 6MHz Rail-To-Rail Output Operational Amplifier

General Description

The LMC2001 is a new precision amplifier that offers unprecedented accuracy and stability at an affordable price and is offered in miniature (SOT23-5) package. This device utilizes patented techniques to measure and continually correct the input offset error voltage. The result is an amplifier which is ultra stable over time, and temperature. It has excellent CMRR and PSRR ratings, and does not exhibit the familiar 1/ f voltage and current noise increase that plagues traditional amplifiers. The combination of the LMC2001 characteristics makes it a good choice for transducer amplifiers, high gain configurations, ADC buffer amplifiers, DAC I-V conversion, and any other 5V application requiring precision and/or stability.

Other useful benefits of the LMC2001 are rail-to-rail output, low supply current of 750μ A, and wide gain-bandwidth product of 6MHz. The LMC2001 comes in 5 pin SOT23 and 8 pin SOIC. These extremely versatile features found in the LMC2001 provide high performance and ease of use.

Features

(Vs = 5V, R_L = 10K to V⁺/2, Typ. Unless Noted)

- Low Guaranteed Vos 40µV -85nV/√Hz en With No 1/f 120dB **High CMRR** Hiah PSRR 120dB High A_{VOL} 137dB Wide Gain-Bandwidth Product 6MHz High Slew Rate 5V/µs Low Supply Current 750µA
 - Rail-To-Rail Output 30mV from either rail
- No External Capacitors Required

Applications

- Precision Instrumentation Amplifiers
- Thermocouple Amplifiers
- Strain Gauge Bridge Amplifier



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

ESD Tolerance (<i>Note 2</i>)	
Human Body Model	2000V
Machine Model	100V
Differential Input Voltage	± Supply Voltage
Supply Voltage (V+ - V-)	5.6V
Current At Input Pin	30mA
Current At Output Pin	30mA
Current At Power Supply Pin (<i>Note 3</i>)	50mA
Lead Temperature (soldering, 10 sec)	260°C

Storage Temperature Range-65°C to 150°CJunction Temperature (T_J)150°C(Note 4)150°C

Operating Ratings (Note 1)

Supply voltage	4.75V to 5.25V
Temperature Range	
LMC2001AI	-40°C ≤ T _J ≤ 85°C
LMC2001AC	$0^{\circ}C \le T_{J} \le 70^{\circ}C$
Thermal resistance (θ_{JA})	
M Package, 8-pin Surface Mount	180°C /W
M5 Package, SOT23-5	274°C /W

DC Electrical Characteristics Unless otherwise specified, all limits guaranteed for T_J = 25°C, V⁺ = 5V, V⁻ = 0V, V_{CM} = 2.5V, V₀ = 2.5V and R_L > 1MΩ. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (Note 5)	Limit (<i>Note 6</i>)	Units
V _{OS}	Input Offset Voltage	(Note 11)	0.5	40 60	μV max
	Offset Calibration Time		5	30	ms
TCV _{OS}	Input Offset Voltage	(Note 12)	0.015		μV/°C
	Long-Term Offset Drift	(Note 8)	0.006		µV/month
	Lifetime V _{OS} drift	(Note 8)	2.5	5	μV Max
I _{IN}	Input Current	(Note 9)	-3		pА
I _{os}	Input Offset Current		6		pА
R _{IND}	Input Differential Resistance		9		MΩ
CMRR	Common Mode Rejection Ratio	$0V \le V_{CM} \le 3.5V$	120	100	dB min
		0.1V ≤ V _{CM} ≤ 3.5V	110	90	dB min
PSRR	Power Supply Rejection Ratio	$4.75V \le V^+ \le 5.25V$	120	95 90	dB min
A _{VOL}	Large Signal Voltage Gain (<i>Note 7</i>)	$R_L = 10 k\Omega$	137	105 100	dB min
		$R_{L} = 2k\Omega$	128	95 90	
Vo	Output Swing	$R_L = 10k\Omega$ to 2.5V V_{IN} (diff) = ±0.5V	4.975	4.955 4.955	V min
			0.030	0.060 0.060	V max
		$R_L = 2k\Omega$ to 2.5V	4.936		V
		$V_{IN}(diff) = \pm 0.5V$	0.075		V
I _O	Output Current	Sourcing, $V_0 = 0V$ $V_{IN}(diff) = \pm 0.5V$	5.9	4.1 1.5	mA min
		Sinking, $V_0 = 5V$ $V_{IN}(diff) = \pm 0.5V$	14.5	4.5 1.5	mA min
I _S	Supply Current		0.75	1.0 1.2	mA max

AC Electrical Characteristics $T_J = 25^{\circ}$ C, V⁺ = 5V, V⁻ = 0V, V_{CM} = 2.5V, V_O = 2.5V, and R_L > 1MΩ.

Symbol	Parameter	Conditions		Typ (<i>Note 5</i>)	Units
SR	Slew Rate	$A_{V} = +1, V_{IN} = 3.5Vpp$		5	V/µs
GBW	Gain-Bandwidth Product			6	MHz
θ _m	Phase Margin			75	Deg
G _m	Gain Margin			12	dB
e _n	Input-Referred Voltage Noise	f = 0.1Hz		85	nV/√Hz
e _n p-p	Input-Referred Voltage Noise	R _s = 100Ω, DC to 10Hz	R _S = 100Ω, DC to 10Hz		μVpp
i _n	Input-Referred Current Noise	f = 0.1Hz		180	fA/√Hz
THD	Total Harmonic Distortion	f = 1 kHz, Av = -2 $R_{\text{L}} = 10 \text{k} \Omega, V_{\Omega} = 4.5 \text{ Vpp}$		0.02	%
trec	Input Overload Recovery Time			50	ms
Ts	Output Settling time	(<i>Note 10</i>) A _V = +1, 1V step	1%	250	ns
			0.1%	400	
			0.01%	3200	
		$(Note \ 10)A_V = -1, 1V \text{ step}$	1%	80	
			0.1%	860	
			0.01%	1400	

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and test conditions, see the Electrical Characteristics. Note 2: Human body model, $1.5k\Omega$ in series with 100pF. Machine model, 200Ω in series with 100pF.

Note 3: Output currents in excess of ±30mA over long term may adversely affect reliability.

Note 4: The maximum power dissipation is a function of T_{J(max)}, θ_{JA} and T_A. The maximum allowable power dissipation at any ambient temperature is P_D =

 $(T_{J(max)} - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly onto a PC board.

Note 5: Typical values represent the most likely parametric norm.

Note 6: All limits are guaranteed by testing or statistical analysis, unless otherwise noted.

Note 7: V⁺ = 5V, V_{CM} = 2.5V, and R_L connected to 2.5V. For Sourcing tests, 2.5V \leq V_O \leq 4.8V. For Sinking tests, 0.2V \leq V_O \leq 2.5V.

Note 8: Guaranteed Vos Drift is based on 280 devices operated for 1000 hrs at 150°C (equivalent to 30 years @ 55°C).

Note 9: Guaranteed by design only.

Note 10: Settling times shown correspond to the worse case (positive or negative step) and does not include slew time. See the Application Note section for test schematic.

Note 11: The limits are set by the accuracy of high speed automatic test equipment. For the typical V_{OS} distribution, see the curve on page 4.

Note 12: Precision bench measurement of more than 300 units. More than 65% of units had less than 15nV /°C V_{OS} drift.

Typical Performance Characteristics $T_A=25C$, $V_S=5V$ unless otherwise specified.



10005863







10005891



10005868



100058a0



5









7

Application Information The Benefits of LMC2001 No 1/f Noise

Using patented methods, the LMC2001 eliminates the 1/f noise present in other amplifiers. This noise which increases as frequency decreases is a major source of measurement error in all DC coupled measurements. Low frequency noise appears as a constantly changing signal in series with any measurement being made. As a result, even when the measurement is made rapidly, this constantly changing noise signal will corrupt the result. The value of this noise signal can be surprisingly large. For example: If a conventional amplifier has a high frequency noise level of $10 \text{ nV}/\sqrt{\text{Hz}}$ and a noise corner of 10 Hz, the RMS noise at 0.001 Hz is $1\mu\text{V}/\sqrt{\text{Hz}}$

This is equivalent to a 6μ V peak-to-peak error. In a circuit with a gain of 1000, this produces a 6mV peak-to-peak output error. This number of 0.001 Hz might appear unreasonably low but when a data acquisition system is operating for 17 minutes it has been on long enough to include this error. In this same time, the LMC2001 will only have a 0.51mV output error. This is more than 13.3 times less error.

Keep in mind that this 1/f error gets even larger at lower frequencies.

At the extreme, many people try to reduce this error by integrating or taking several samples of the same signal. This is also doomed to failure because the 1/f nature of this noise means that taking longer samples just moves the measurement into lower frequencies where the noise level is even higher.

The LMC2001 eliminates this source of error. The noise level is constant with frequency so that reducing the bandwidth reduces the errors caused by noise.

Another source of error that is rarely mentioned is the error voltages caused by the inadvertent thermocouples created when the common "Kovar type" package lead materials are soldered to a copper printed circuit board. These steel based leadframe materials can produce over 35uV/°C when soldered onto a copper trace. This can result in thermocouple noise that is equal to the LMC2001 noise when there is a temperature difference of only 0.0014°C between the lead and the board!

For this reason, the leadframe of the LMC2001 is made of copper. This results in equal and opposite junctions which cancel this effect. The extremely small size of the SOT-23 package results in the leads being very close together. This further reduces the probability of temperature differences and hence decreases thermal noise.

Overload Recovery

The LMC2001 recovers from input overload much faster than most chopper stabilized opamps. Recovery, from driving the amplifier to 2X the full scale output, only requires about 50ms. Most chopper stabilized amplifiers will take from 250ms to several seconds to recover from this same overload. This is because large capacitors are used to store the unadjusted offset voltage.

The wide bandwidth of the LMC2001 enhances performance when it is used as an amplifier to drive loads that inject transients back into the output. A to Ds and multiplexers are examples of this type of load. To simulate this type of load, a pulse generator producing a 1V peak square wave was connected to the output through a 10pF capacitor. (*Figure 1*) The typical time for the output to recover to 1% of the applied pulse is 80ns. To recover to 0.1% requires 860ns. This rapid recov-

ery is due to the wide bandwidth of the output stage and large total GBW.



FIGURE 1.

No External Capacitors Required

The LMC2001 does not need external capacitors. This eliminates the problems caused by capacitor leakage and dielectric absorption, which can cause delays of several seconds from turn-or until the amplifier is settled.

More Benefits

The LMC2001 offers the benefits mentioned above and more. It is rail-to-rail output and consumes only 750 μ A of supply current while providing excellent DC and AC electrical performance. In DC performance, the LMC2001 achieves 120dB of CMRR, 120dB of PSRR and 137dB of open loop gain. In AC performance, the LMC2001 provides 6MHz of gain-bandwidth product and 5V/µs of slew rate.

How the LMC2001 Works

The LMC2001 uses new, patented techniques to achieve the high DC accuracy traditionally associated with chopper stabilized amplifiers without the major drawbacks produced by chopping. The LMC2001 continuously monitors the input offset and corrects this error. The conventional chopping process produces many mixing products, both sums and differences, between the chopping frequency and the incoming signal frequency. This mixing causes large amounts of distortion, particularly when the signal frequency approaches the chopping frequency. Even without an incoming signal, the chopper harmonics mix with each other to produce even more trash. If this sounds unlikely or difficult to understand, look at the plot (Figure 2), of the output of a typical (MAX432) chopper stabilized opamp. This is the output when there is no incoming signal, just the amplifier in a gain of -10 with the input grounded. The chopper is operating at about 150Hz, the rest is mixing products. Add an input signal and the mess gets much worse. Compare this plot with Figure 3 of the LMC2001. This data was taken under the exact same conditions. The auto zero action is visible at about 11kHz but note the absence of mixing products at other frequencies. As a result, the LMC2001 has very low distortion of 0.02% and very low mixing products.

Input Currents

The LMC2001 input current is different than standard bipolar or CMOS input currents in that it appears as a current flowing in one input and out the other. Under most operating conditions, these currents are in the picoamp level and will have little or no effect in most circuits. These currents increase to the nA level when the common-mode voltage is near the minus supply. (see the typical curves) At high temperatures such as 85°C, the input currents become larger, 0.5nA typical, and are both positive except when the Vcm is near V-. If operation is expected at low common-mode voltages and high temperature, do not add resistance in series with the inputs to balance the impedances. Doing this can cause an increase in offset voltage.







FIGURE 3.

This Strain-Gauge (*Figure 4*) amplifier provides high gain (1006 or 60 dB) with very low offset and drift. Using the resistors tolerance as shown, the worst case CMRR will be greater than 90 dB. The common-mode gain is directly related to the resistor mismatch and is independent of the differential gain that is set by R3. The worst case common-mode gain is –54 dB. This gain becomes even lower, improving CMRR, if the resistor ratio matching is improved.

$$A_V \text{ Diff} = 1 + \frac{R1}{R2} + \frac{2R1}{R3}$$

Extending Supply Voltages and Output Swing by Using a Composite Amplifier Configuration:

In cases where substantially higher output swing is required with higher supply voltages, arrangements like the ones shown in *Figure 5*, and *Figure 6* could be used (pin numbers shown are for SO-8 package). These configurations utilize the excellent DC performance of the LMC2001 while at the same time allow the superior voltage and frequency capabilities of the LM6171 to set the dynamic performance of the overall amplifier. For example, it is possible to achieve ±12V output swing with 300MHz of overall GBW (Av=100) while keeping the worst case output shift due to Vos less than 4mV. The LMC2001 output voltage is kept at about mid-point of it's

overall supply voltage and it's input common mode voltage range allows the V⁻ terminal to be grounded in one case (*Figure 5*, inverting operation) and tied to a small non-critical negative bias in another (*Figure 6*, non-inverting operation). Higher closed loop gains are also possible with a corresponding reduction in realizable bandwidth. Table 1 shows some other closed loop gain possibilities along with the measured performance in each case

Application Circuits











FIGURE 6. Non-Inverting Composite Amplifier

Av	R1	R2	C2	BW	SR	e _{npp}
	(ohm)	(ohm)	(pF)	(MHz)	(V/us)	(mVpp)
50	200	10K	8	3.3	178	37
100	100	10K	10	2.5	174	70
100	1K	100K	0.67	3.1	170	70
500	200	100K	1.75	1.4	96	250
1000	100	100K	2.2	0.98	64	400

TABLE 1. Composite Amplifier Measured Perfo	rmance
---	--------

In terms of the measured output peak-to-peak noise, the following relationship holds between output noise voltage, e_{npp} , for different closed loop gain, A_v , settings, where -3dB Bandwidth is BW:

$$\frac{e_{npp1}}{e_{npp2}} = \sqrt{\frac{BW1}{BW2}} \cdot \frac{A_V 1}{A_V 2}$$
(1)

It should be kept in mind that in order to minimize the output noise voltage for a given closed loop gain setting, one could minimize the overall bandwidth. As can be seen from Equation 1 above, the improvement in output noise has a square law relationship to the reduction in BW. In the case of the inverting configuration, it is also possible to increase the input impedance of the overall amplifier, by raising the value of R1, without having to increase the feedback resistor, R2, to impractical values, by utilizing a "T" network as feedback. See the LMC6442 data sheet (Application Notes section) for more details on this.

LMC2001 as ADC Input Amplifier

The LMC2001 is a great choice for an amplifier stage immediately before the input of an A/D converter (AC or DC coupled) see *Figure 7* and *Figure 8* because of the following important characteristics:

a) Very low offset voltage and offset voltage drift over time and temperature allow a high closed loop gain setting without introducing any short term or long term errors. For example, when set to a closed loop gain of 100 as the analog input amplifier of a 12 bit A/D converter, the overall conversion error over full operation temperature and 30 years life of the part (operating at 50°C) would be less than 5LSB.

b) Fast large signal settling time to 0.01% of final value (1.4 us) allows 12 bit accuracy at 100KHz or more sampling rate.

c) No flicker (1/f) noise means unsurpassed data accuracy over any measurement period of time, no matter how long. Consider the following opamp performance, based on a typical commercially available device, for comparison:

Opamp flatband noise	8nV/√Hz
1/f0.94 corner frequency	100Hz
f(max)	100Hz
Av	100
Measurement time	100 sec

The example above, will result in about 3mVpp (2.5LSB) of output noise contribution due to the opamp alone, compared to about 420 uVpp (less than 1LSB) when that opamp is replaced with the LMC2001 which has no 1/f contribution. If the measurement time is increased from 100 sec. to 1 hr., the improvement realized by using the LMC2001 would be a factor of about 44 times (18.5mVpp compared to 420uV when LMC2001 is used) mainly because the LMC2001 accuracy is not compromised by increasing the observation time.

d) Copper lead frame construction minimizes any thermocouple effects which would degrade low level/high gain data conversion application accuracy (see discussion under "The Benefits of the LMC2001" section above).

e) Rail-to-Rail output swing maximized the ADC dynamic range in 5V single supply converter applications. Below are some typical block diagrams showing the LMC2001 used as an ADC amplifier (*Figure 7* and *Figure 8*).



			•		•
	Commercial	Industrial			
	0°C to +70°C	-40°C to +85°C			
8-pin Small Outline		LMC2001AIM	LMC2001AIM	Rails	M08A
		LMC2001AIMX		2.5k Units Tape and	
				Reel	
5-pin SOT23-5	LMC2001ACM5		A09A	1k Units Tape and	MA05B
				Reel	
	LMC2001ACM5X			3k Units Tape and	
				Reel	





Notes

For more National Semiconductor product information and proven design tools, visit the following Web sites at: www.national.com

Products		Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench	
Audio	www.national.com/audio	App Notes	www.national.com/appnotes	
Clock and Timing	www.national.com/timing	Reference Designs	www.national.com/refdesigns	
Data Converters	www.national.com/adc	Samples	www.national.com/samples	
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
Temperature Sensors	www.national.com/tempsensors	SolarMagic™	www.national.com/solarmagic	
PLL/VCO	www.national.com/wireless	PowerWise® Design University	www.national.com/training	

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS, PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS. NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

Copyright© 2011 National Semiconductor Corporation

For the most current product information visit us at www.national.com



National Semiconductor Americas Technical Support Center Email: support@nsc.com ww.national.com Tel: 1-800-272-9959

National Semiconductor Europe **Technical Support Center** Email: europe.support@nsc.com

National Semiconductor Asia Pacific Technical Support Center Email: ap.support@nsc.com

National Semiconductor Japan **Technical Support Center** Email: ipn.feedback@nsc.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated